

**Amendments to the Specification**

Please amend the text at page 10, lines 5 to 7, as shown below:

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*a* The use of external heating ~~yields the allowance of~~  
*b* enables the independent control of the temperature of  
glass substrate 320 ~~temperature~~ and magnetic flux  
density on silicon film ~~films~~ 220, which is not the  
case in the embodiments of FIGS 1 and 2.

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